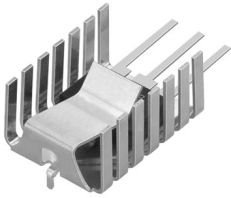


Data sheet Product FK 243 MI 247 H



Board Level heatsinks>Attachable heatsink
horizontal mounting, for semiconductor-design TO 218, TO 220, TO 247

Features

material:	copper (Cu)
for transistor:	<ul style="list-style-type: none"> • TO 220 • TO 248 • SIP-Multiwatt • TO 247 • TO 218
width:	20 mm
height:	13 mm
length:	27 mm
thermal resistance:	19 K/W
surface:	solderable surface
version:	with solder lug for horizontal installation
material thickness:	0.6 mm

Technical Drawing

